

WHAT IS CLAIMED IS:

1. An integrated circuit, comprising:  
a fuse corner pad located at a first corner of the integrated circuit,  
wherein said fuse corner pad includes a fuse contact coupled to said fuse corner pad.
2. The integrated circuit of claim 1, further comprising:  
a fuse element connected to said fuse contact.
3. The integrated circuit of claim 2, wherein said fuse element is adapted to adjust a transmitting waveform to comply with a predefined parameter.
4. The integrated circuit of claim 2, wherein said fuse element is adapted to communicate a state of said fuse element, said state identifying the integrated circuit.
5. The integrated circuit of claim 1, wherein said fuse contact is capable of being probed without being bonded to an external connection.
6. The integrated circuit of claim 1, further comprising:  
an auxiliary pad coupled to said fuse corner pad.
7. The integrated circuit of claim 6, wherein said auxiliary pad is a second fuse contact.
8. The integrated circuit of claim 6, wherein said auxiliary pad communicates signals for circuit testing.

9. A fuse corner pad located at a corner of a semiconductor die, comprising:

a fuse contact coupled to the fuse corner pad; and  
a fuse element connected to said fuse contact.

10. The fuse corner pad of claim 9, wherein said fuse contact is capable of being probed without being bonded to an external connection.

11. A semiconductor die, comprising:

at least one I/O pad, on the semiconductor die, for communicating signals; and

a fuse corner pad having a fuse integrated within said fuse corner pad, wherein said fuse corner pad is located at a corner of the semiconductor die.

12. The semiconductor die of claim 11, wherein said fuse corner pad is capable of being probed without being bonded to an external connection.

13. The semiconductor die of claim 11, wherein said fuse corner pad is one of four fuse corner pads, wherein each of said four fuse corner pads is located at a respective corner of the semiconductor die.

14. An integrated circuit, comprising:

a fuse corner pad located at a first corner of the integrated circuit,

wherein said fuse corner pad includes a plurality of fuse contacts coupled to said fuse corner pad.

15. The integrated circuit of claim 14, wherein at least one of said plurality of fuse contacts is connected to a fuse element included in the integrated circuit.